# imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



## Contact us

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### **Schottky Barrier Rectifier**

#### FEATURES

- Low power loss, high efficiency
- Guardring for overvoltage protection
- High surge current capability
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21 definition

#### MECHANICAL DATA

#### Case: TO-220AC

Molding compound, UL flammability classification rating 94V-0

Base P/N with suffix "G" on packing code - halogen-free

Base P/N with prefix "H" on packing code - AEC-Q101 qualified

Terminal: Matte tin plated leads, solderable per JESD22-B102

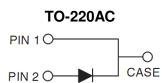
Meet JESD 201 class 1A whisker test,

with prefix "H" on packing code meet JESD 201 class 2 whisker test **Polarity:** As marked

Mounting torque: 5 in-lbs maximum

Weight: 1.88 g (approximately)







ROHS

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS (T <sub>A</sub> =25°C unless otherwise noted)										
PARAMETER	SYMBOL	MBR	MBR	MBR	MBR	MBR	MBR	MBR	MBR	UNIT
		1035	1045	1050	1060	1090	10100	10150	10200	
Maximum repetitive peak reverse voltage	V <sub>RRM</sub>	35	45	50	60	90	100	150	200	V
Maximum RMS voltage	V <sub>RMS</sub>	24	31	35	42	63	70	105	140	V
Maximum DC blocking voltage	V <sub>DC</sub>	35	45	50	60	90	100	150	200	V
Maximum average forward rectified current	I <sub>F(AV)</sub>	10						А		
Peak repetitive forward current (Rated VR, Square Wave, 20KHz)	I <sub>FRM</sub>	20						A		
Peak forward surge current, 8.3 ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	150						A		
Peak repetitive reverse surge current (Note 1)	I <sub>RRM</sub>	1.0 0.5				А				
Maximum instantaneous forward voltage (Note 2) $I_F$ =10A, $T_J$ =25 $^{\circ}$ C $I_F$ =10A, $T_J$ =125 $^{\circ}$ C	V <sub>F</sub>	_	70 57		80 70	-	85 71	1.	05	V
Maximum reverse current @ rated VR T_=25 $^{\circ}$ C		0.1								
T <sub>J</sub> =125 ℃	I <sub>R</sub>	1	5	1	0	6			- mA	
Voltage rate of change (Rated V <sub>R</sub> )	dV/dt	10000					V/µs			
Typical thermal resistance	R <sub>θJC</sub>	3					<sup>o</sup> C/W			
Operating junction temperature range	TJ	- 55 to +150					°C			
Storage temperature range	T <sub>STG</sub>	- 55 to +175					°C			
Note 1: to = $2.0 \mu c$ $1.0 \text{KHz}$										

Note 1: tp = 2.0 µs, 1.0KHz

Note 2: Pulse test with PW=300µs, 1% duty cycle

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Version: L13



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ORDERING INF	ORMATION
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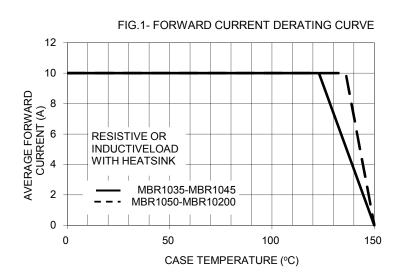
on behind in on marion							
PART NO.	AEC-Q101	PACKING CODE	GREEN COMPOUND	PACKAGE	PACKING		
FART NO.	QUALIFIED	FACKING CODE	CODE	FACKAGE	FACKING		
MBR10xx (Note 1)	Prefix "H"	C0	Suffix "G"	TO-220AC	50 / Tube		

Note 1: "xx" defines voltage from 35V (MBR1035) to 200V (MBR10200)

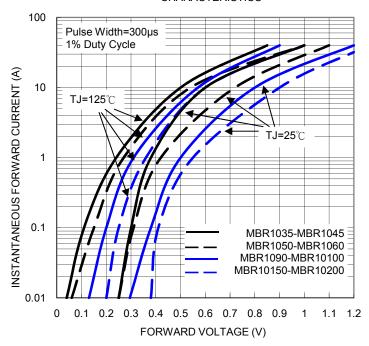
EXAMPLE								
PREFERRED P/N	PART NO.	AEC-Q101 QUALIFIED	PACKING CODE	GREEN COMPOUND CODE	DESCRIPTION			
MBR1060 C0	MBR1060		C0					
MBR1060 C0G	MBR1060		C0	G	Green compound			
MBR1060HC0	MBR1060	Н	C0		AEC-Q101 qualified			

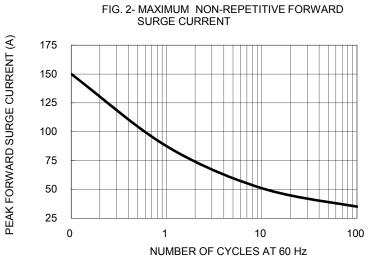
#### **RATINGS AND CHARACTERISTICS CURVES**

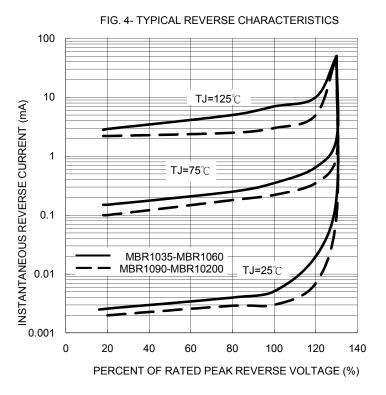
(TA=25°C unless otherwise noted)





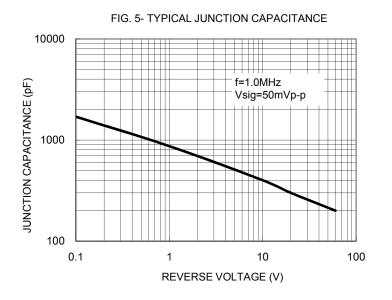


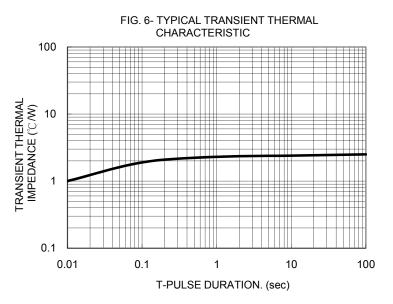




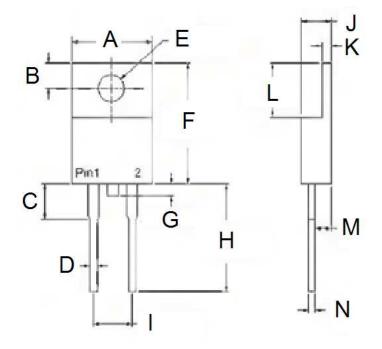


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#### PACKAGE OUTLINE DIMENSIONS



DIM.	Unit	(mm)	Unit (inch)		
Diwi.	Min	Max	Min	Max	
А	-	10.50	-	0.413	
В	2.62	3.44	0.103	0.135	
С	2.80	4.20	0.110	0.165	
D	0.68	0.94	0.027	0.037	
E	3.54	4.00	0.139	0.157	
F	14.60	16.00	0.575	0.630	
G	0.00	1.60	0.000	0.063	
Н	13.19	14.79	0.519	0.582	
	4.95	5.20	0.195	0.205	
J	4.42	4.76	0.174	0.187	
К	1.14	1.40	0.045	0.055	
L	5.84	6.86	0.230	0.270	
М	2.20	2.80	0.087	0.110	
Ν	0.35	0.64	0.014	0.025	

#### MARKING DIAGRAM



= Marking Code

= Green Compound

- = Date Code
- = Factory Code



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